

BFP640

Surface mount high linearity silicon NPN RF bipolar transistor



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Technical documents



Simulation



Support

Product description

The BFP640 is a RF bipolar transistor based on SiGe:C technology that is part of Infineon's established sixth generation transistor family. Its transition frequency f_T of 42 GHz and high linearity characteristics at low currents make this device particularly suitable for energy efficiency designs at frequency as high as 8 GHz. It remains cost competitive without compromising on ease of use.



Feature list

- Minimum noise figure $NF_{min} = 0.65$ dB at 1.9 GHz, 3 V, 6 mA
- High gain $G_{ma} = 24$ dB at 1.9 GHz, 3 V, 25 mA
- $OIP_3 = 26.5$ dBm at 1.9 GHz, 3 V, 25 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Low noise amplifiers (LNAs) in GNSS receivers
- LNAs in satellite radio (SDARs, DAB) receivers
- LNAs in multimedia applications such as CATV and FM radio

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP640 / BFP640H6327XTSA1	SOT343	1 = B	2 = E	3 = C	4 = E	R4s	3000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25\text{ °C}$ (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	4.1	V	Open base
			3.6		$T_A = -55\text{ °C}$, open base
Collector emitter voltage	V_{CES}		13		E-B short circuited
Collector base voltage	V_{CBO}		13		Open emitter
Emitter base voltage	V_{EBO}		1.2		Open collector
Base current	I_B		3	mA	–
Collector current	I_C		50		
Total power dissipation ¹⁾	P_{tot}		200	mW	$T_S \leq 90\text{ °C}$
Junction temperature	T_J	–55	150	°C	–
Storage temperature	T_{Stg}				

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

¹ T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	300	–	K/W	–

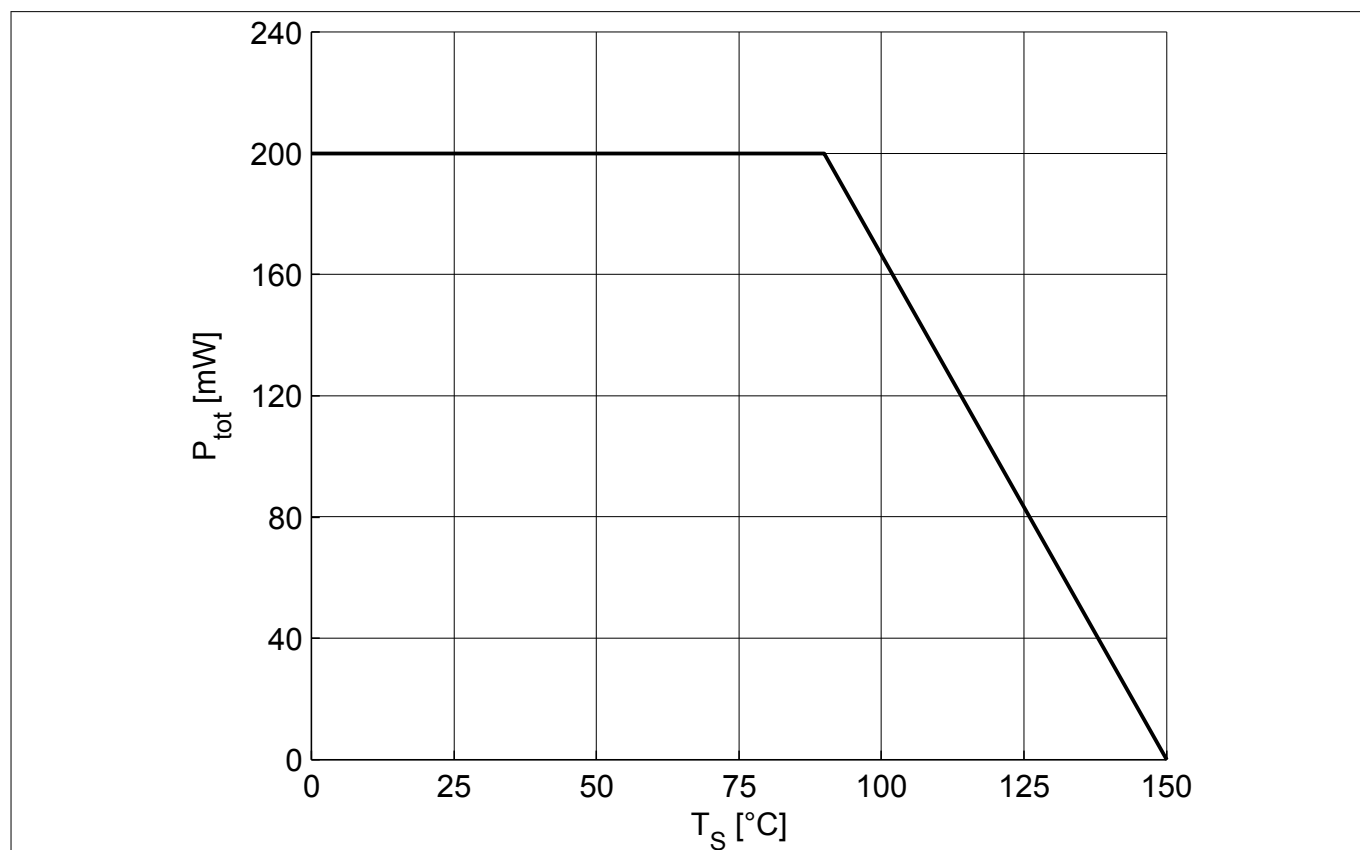


Figure 1 Total power dissipation $P_{tot} = f(T_S)$

Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	4.1	4.7	–	V	$I_C = 1\text{ mA}$, $I_B = 0$, open base
Collector emitter leakage current	I_{CES}	–	1	400 ²⁾	nA	$V_{CE} = 13\text{ V}$, $V_{BE} = 0$, E-B short circuited
			1	40 ²⁾		$V_{CE} = 5\text{ V}$, $V_{BE} = 0$, E-B short circuited
			1	40 ²⁾		$V_{CB} = 5\text{ V}$, $I_E = 0$, open emitter
Collector base leakage current	I_{CBO}		1	40 ²⁾		$V_{EB} = 0.5\text{ V}$, $I_C = 0$, open collector
DC current gain	h_{FE}	110	180	270		$V_{CE} = 3\text{ V}$, $I_C = 30\text{ mA}$, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	42	–	GHz	$V_{CE} = 3\text{ V}$, $I_C = 30\text{ mA}$, $f = 2\text{ GHz}$
Collector base capacitance	C_{CB}		0.08		pF	$V_{CB} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, emitter grounded
Collector emitter capacitance	C_{CE}		0.24			$V_{CE} = 3\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, base grounded
Emitter base capacitance	C_{EB}		0.51			$V_{EB} = 0.5\text{ V}$, $V_{CB} = 0$, $f = 1\text{ MHz}$, collector grounded

² Maximum values not limited by the device but by the short cycle time of the 100% test.

Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_A = 25^\circ\text{C}$.

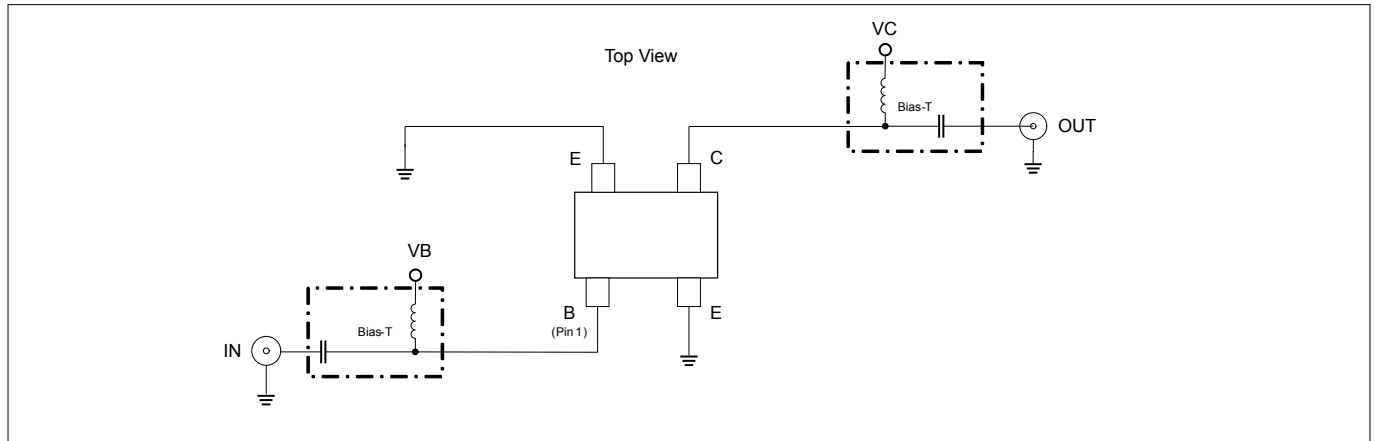


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 450\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ms} $ S_{21} ^2$	–	33 31.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.55 26			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		23.5 10.5		dBm	$I_C = 25\text{ mA}$, $Z_S = Z_L = 50\ \Omega$

Table 7 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 900\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ms} $ S_{21} ^2$	–	29 27.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.6 24			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		25.5 12		dBm	$I_C = 25\text{ mA}$, $Z_S = Z_L = 50\ \Omega$

Electrical characteristics

Table 8 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 1.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ms} $ S_{21} ^2$	–	25.5 23.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.6 21			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		25.5 11.5		dBm	$I_C = 25\text{ mA}, Z_S = Z_L = 50\text{ }\Omega$

Table 9 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 1.9\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ms} $ S_{21} ^2$	–	24 21.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.65 19.5			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		26.5 12.5		dBm	$I_C = 25\text{ mA}, Z_S = Z_L = 50\text{ }\Omega$

Table 10 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 2.4\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ms} $ S_{21} ^2$	–	22 19.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.7 18			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		27.5 12		dBm	$I_C = 25\text{ mA}$, $Z_S = Z_L = 50\text{ }\Omega$

Electrical characteristics

Table 11 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 3.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain <ul style="list-style-type: none">Maximum power gainTransducer gain	G_{ma} $ S_{21} ^2$	–	18 16.5	–	dB	$I_C = 25\text{ mA}$
Noise figure <ul style="list-style-type: none">Minimum noise figureAssociated gain	NF_{min} G_{ass}		0.85 15			$I_C = 6\text{ mA}$
Linearity <ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output	OIP_3 OP_{1dB}		27.5 12		dBm	$I_C = 25\text{ mA}, Z_S = Z_L = 50\ \Omega$

Table 12 AC characteristics, $V_{CE} = 3\text{ V}$, $f = 5.5\text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition	
		Min.	Typ.	Max.			
Power gain	G_{ma} $ S_{21} ^2$	–	14	–	dB	$I_C = 25\text{ mA}$	
<ul style="list-style-type: none">Maximum power gainTransducer gain			12.5				
Noise figure	NF_{min} G_{ass}		1.1				$I_C = 6\text{ mA}$
<ul style="list-style-type: none">Minimum noise figureAssociated gain			12				
Linearity	OIP_3 OP_{1dB}		27.5			dBm	$I_C = 25\text{ mA}$, $Z_S = Z_L = 50\text{ }\Omega$
<ul style="list-style-type: none">3rd order intercept point at output1 dB gain compression point at output			12.5				

Note: $G_{ms} = |S_{21}| / |S_{12}|$ for $k < 1$; $G_{ma} = |S_{21}| / |S_{12}| (k - (k^2 - 1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is $50\ \Omega$ from 0.2 MHz to 12 GHz.

Electrical characteristics

3.4 Characteristic DC diagrams

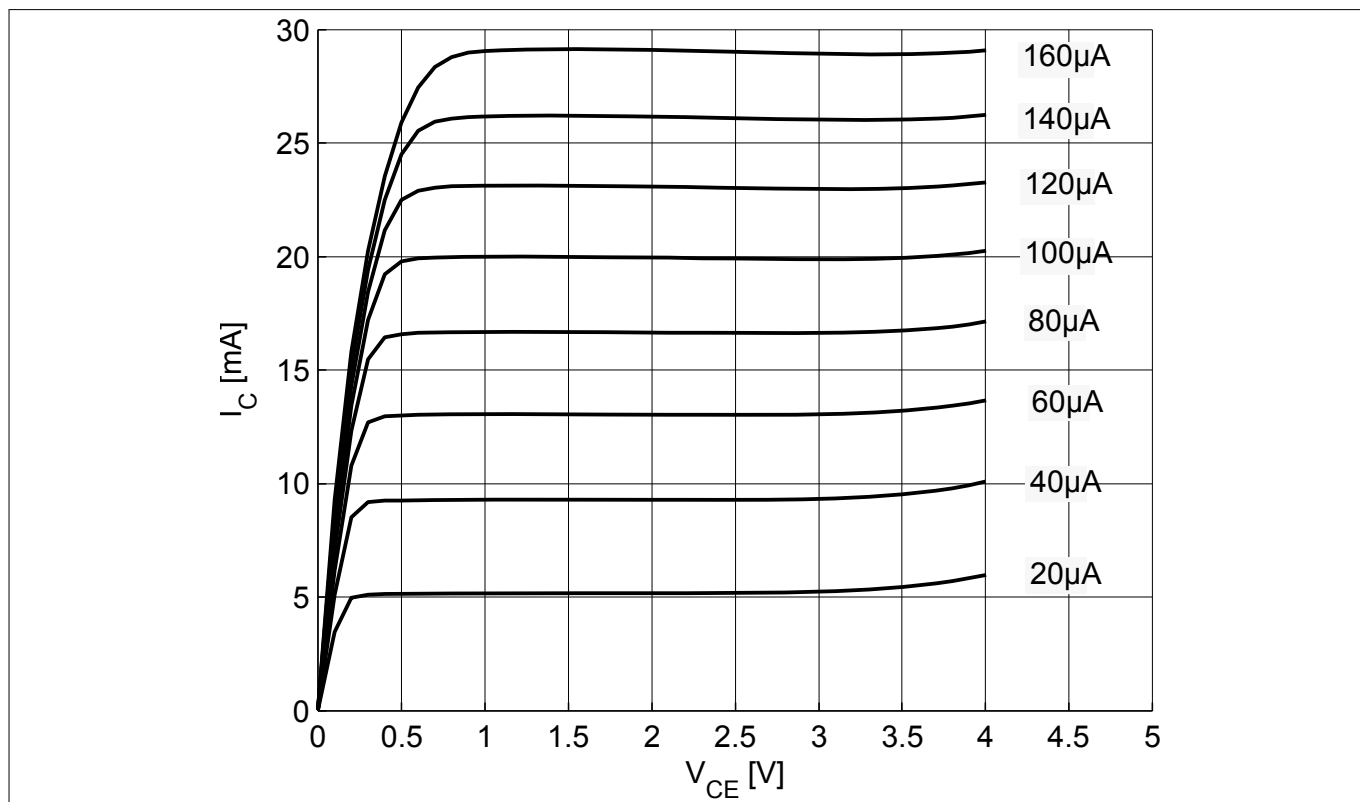


Figure 3 Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, $I_B = \text{parameter}$

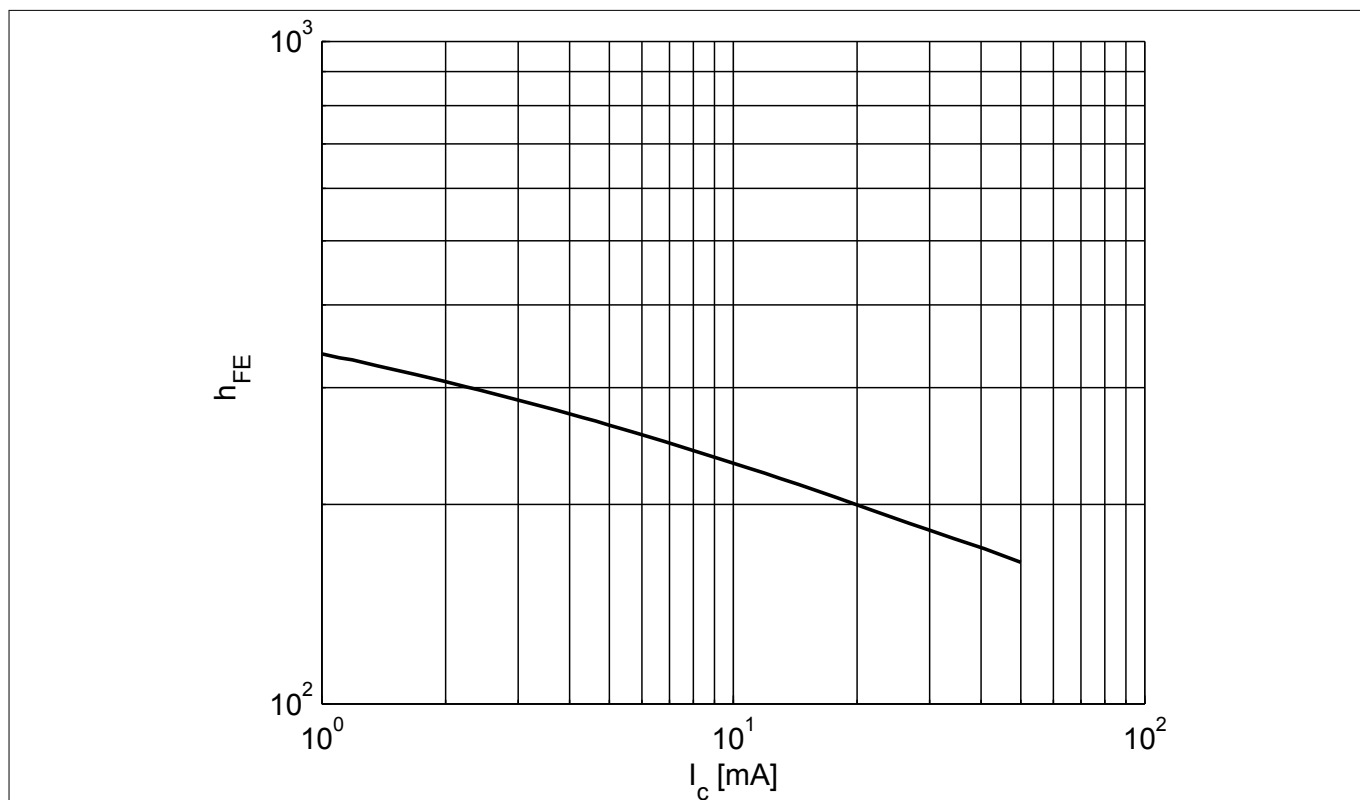


Figure 4 DC current gain $h_{FE} = f(I_C)$, $V_{CE} = 3 \text{ V}$

Electrical characteristics

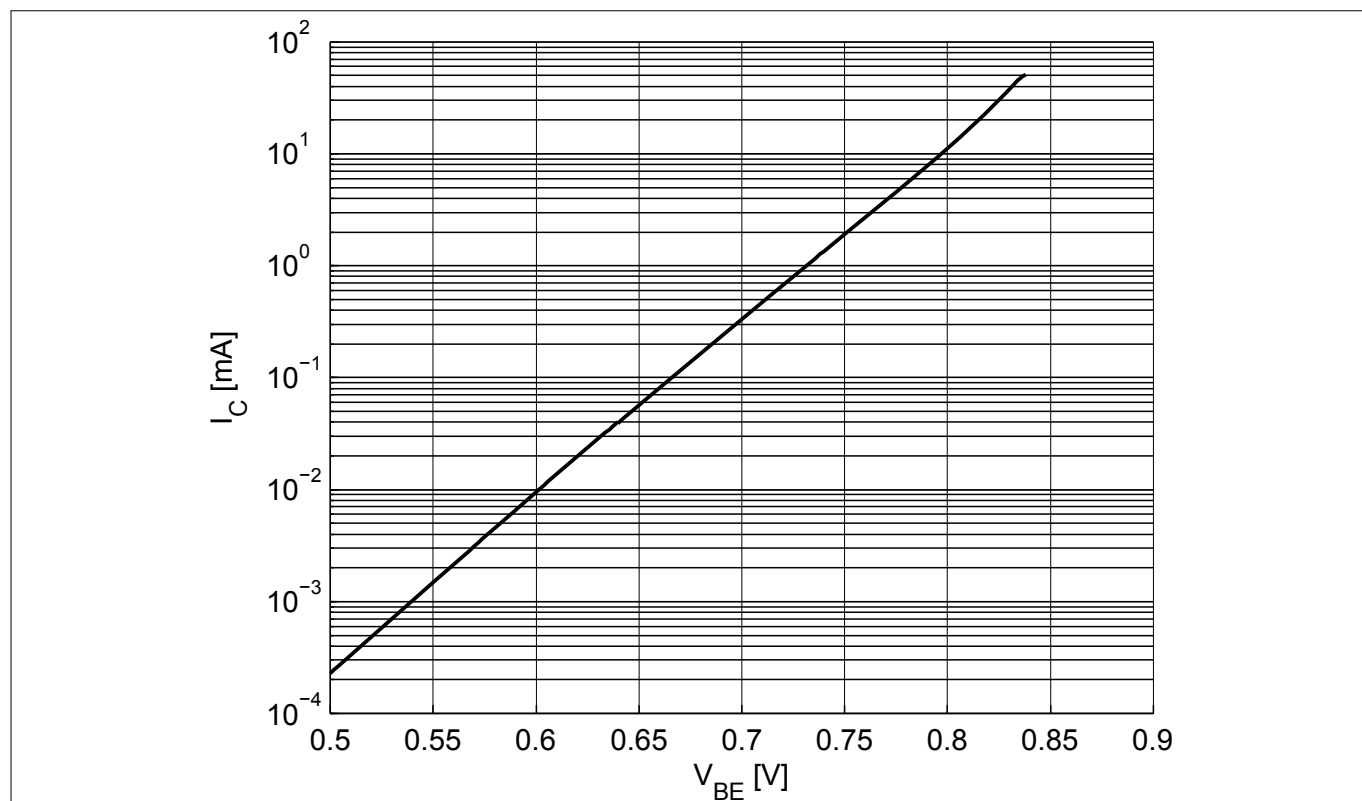


Figure 5 Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 2\text{ V}$

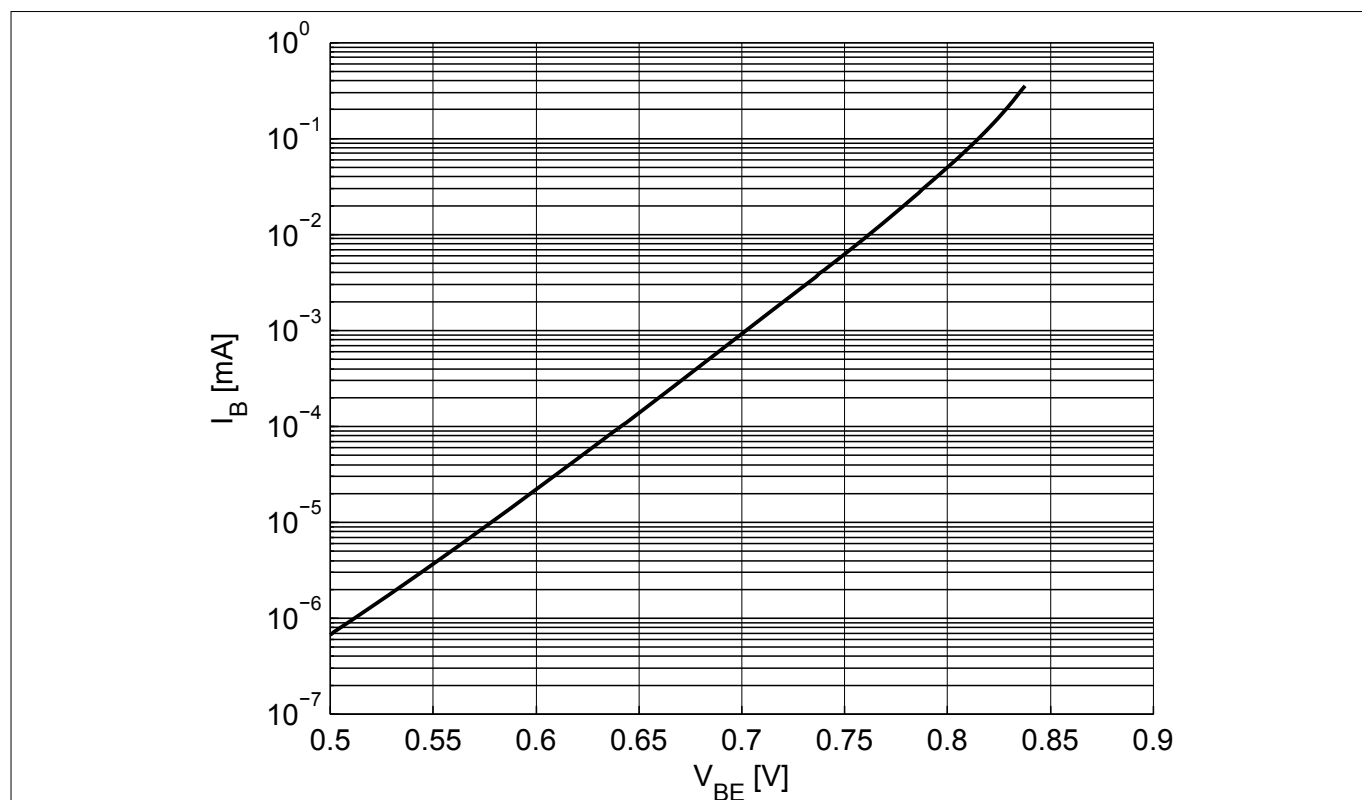


Figure 6 Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 2\text{ V}$

Electrical characteristics

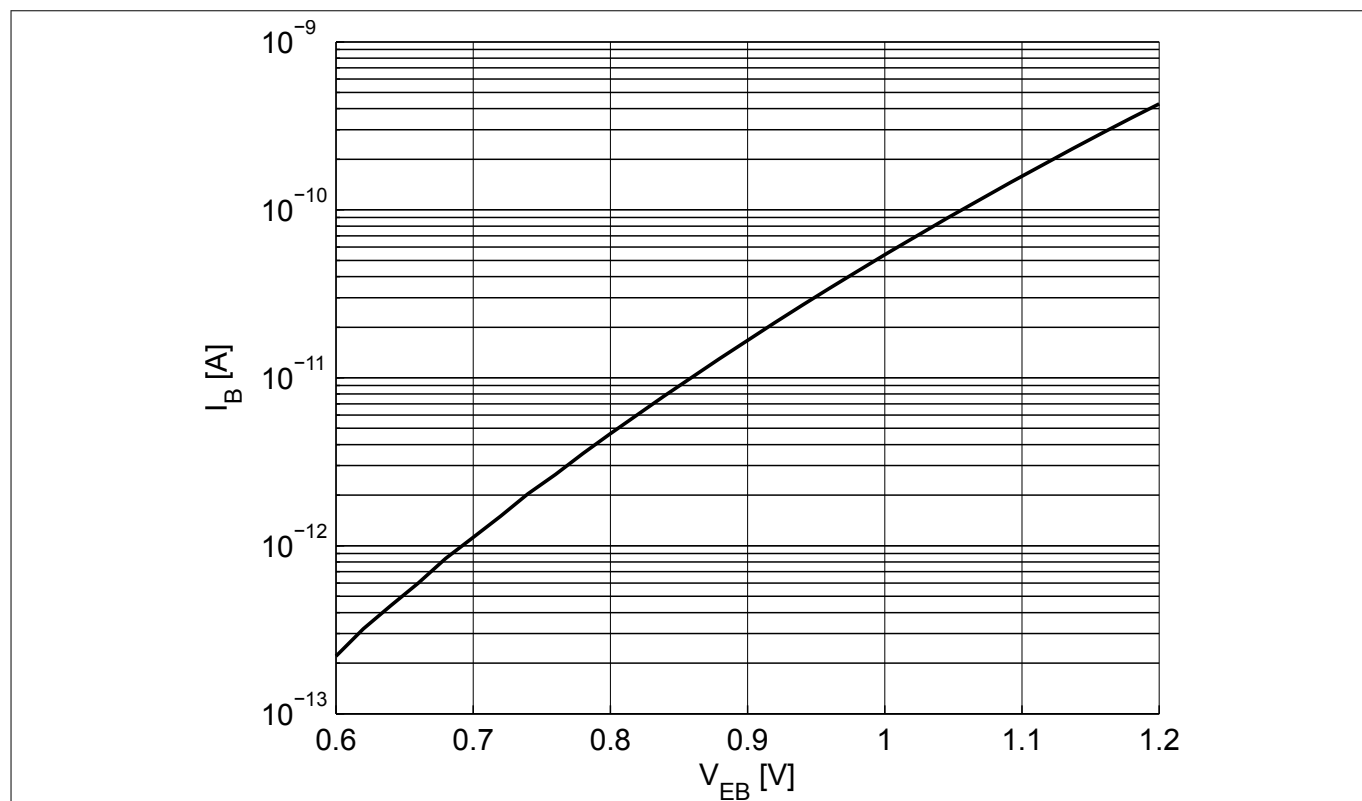


Figure 7 Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 2 \text{ V}$

Electrical characteristics

3.5 Characteristic AC diagrams

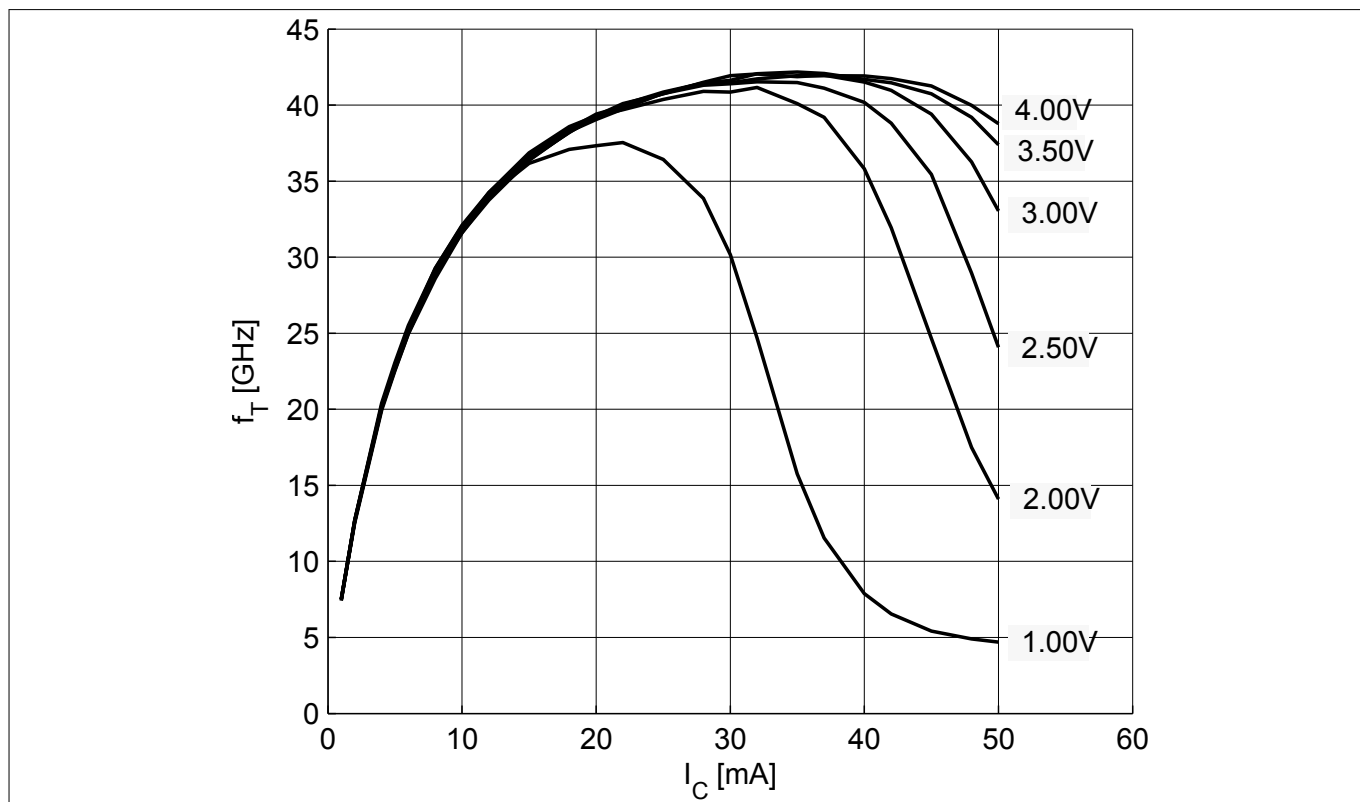


Figure 8 Transition frequency $f_T = f(I_C)$, $f = 2$ GHz, $V_{CE} = \text{parameter}$

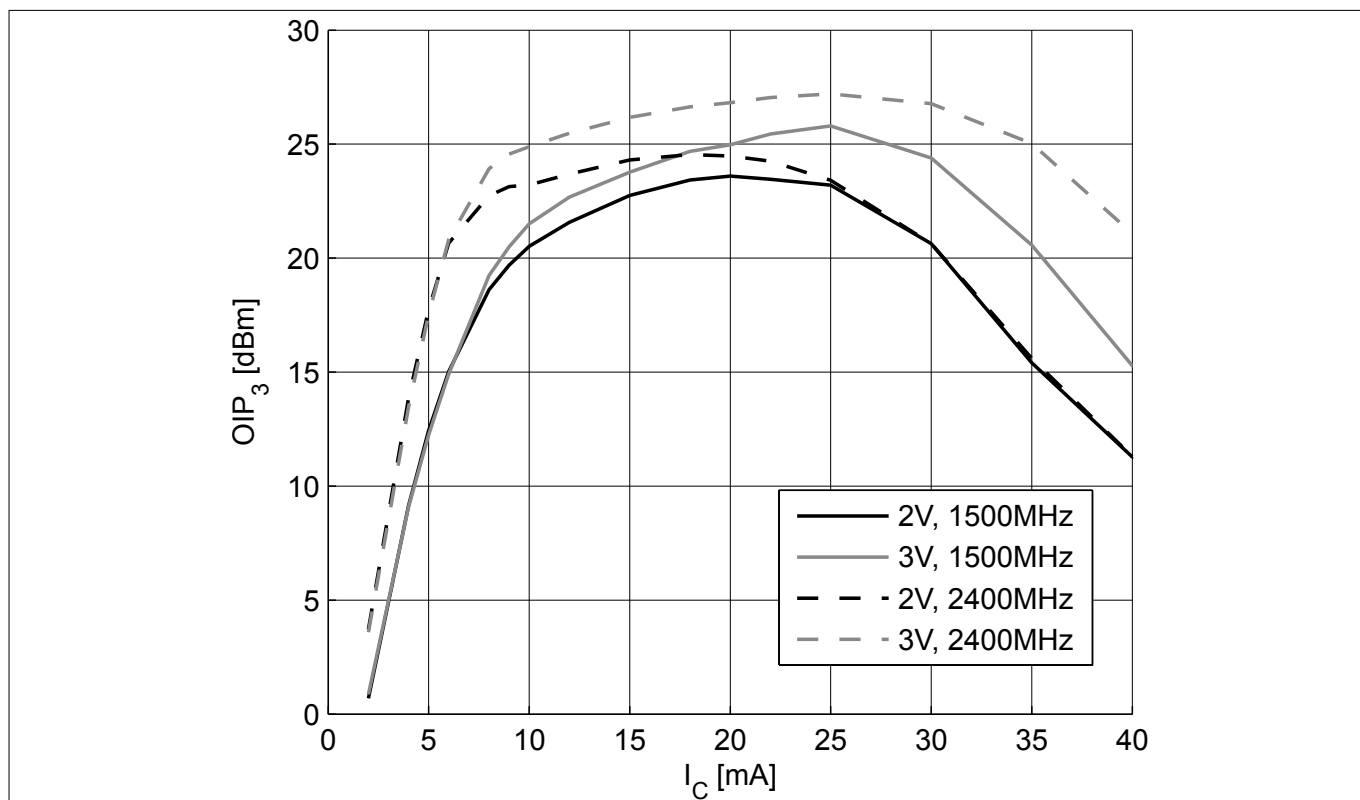


Figure 9 3rd order intercept point $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , $f = \text{parameters}$

Electrical characteristics

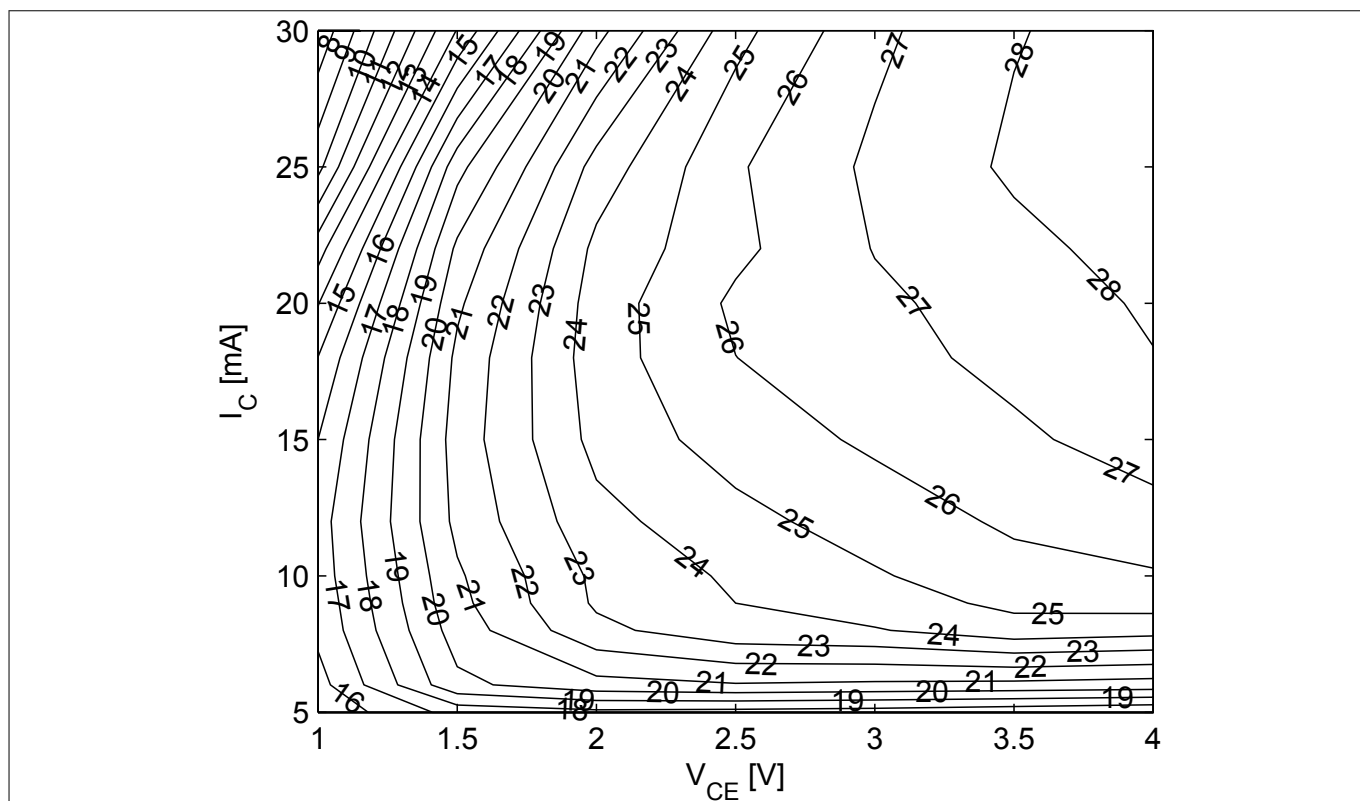


Figure 10 3rd order intercept point at output OIP_3 [dBm] = $f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 2.4$ GHz

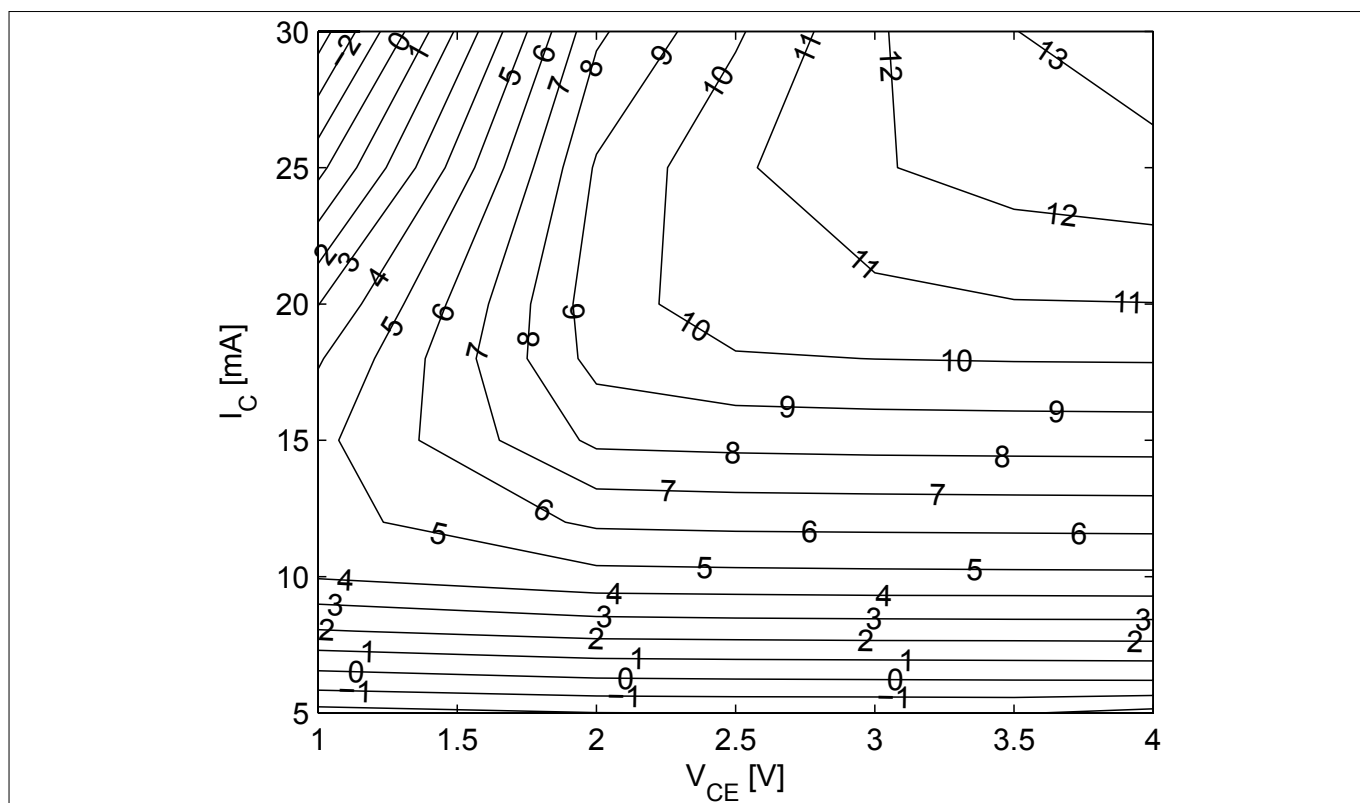


Figure 11 Compression point at output OP_{1dB} [dBm] = $f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 2.4$ GHz

Electrical characteristics

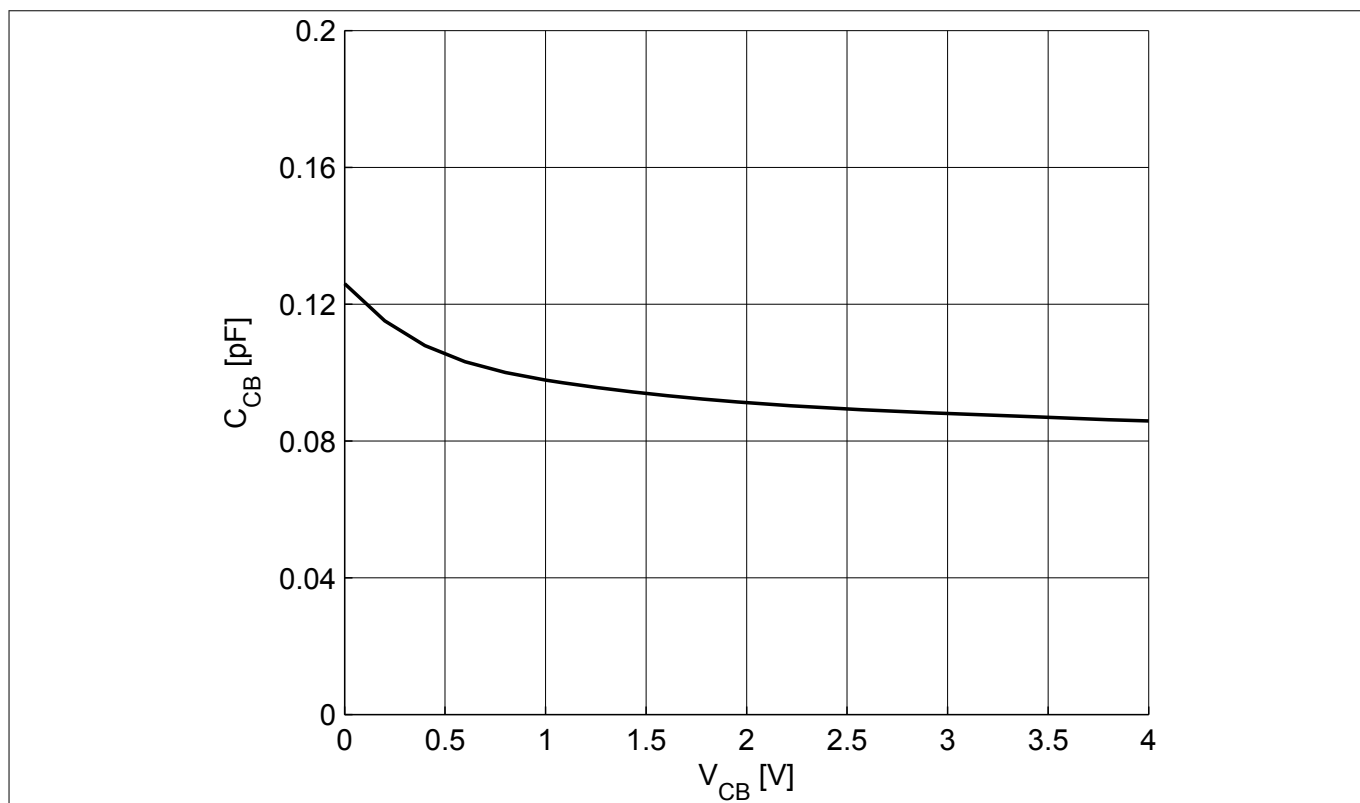


Figure 12 Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1$ MHz

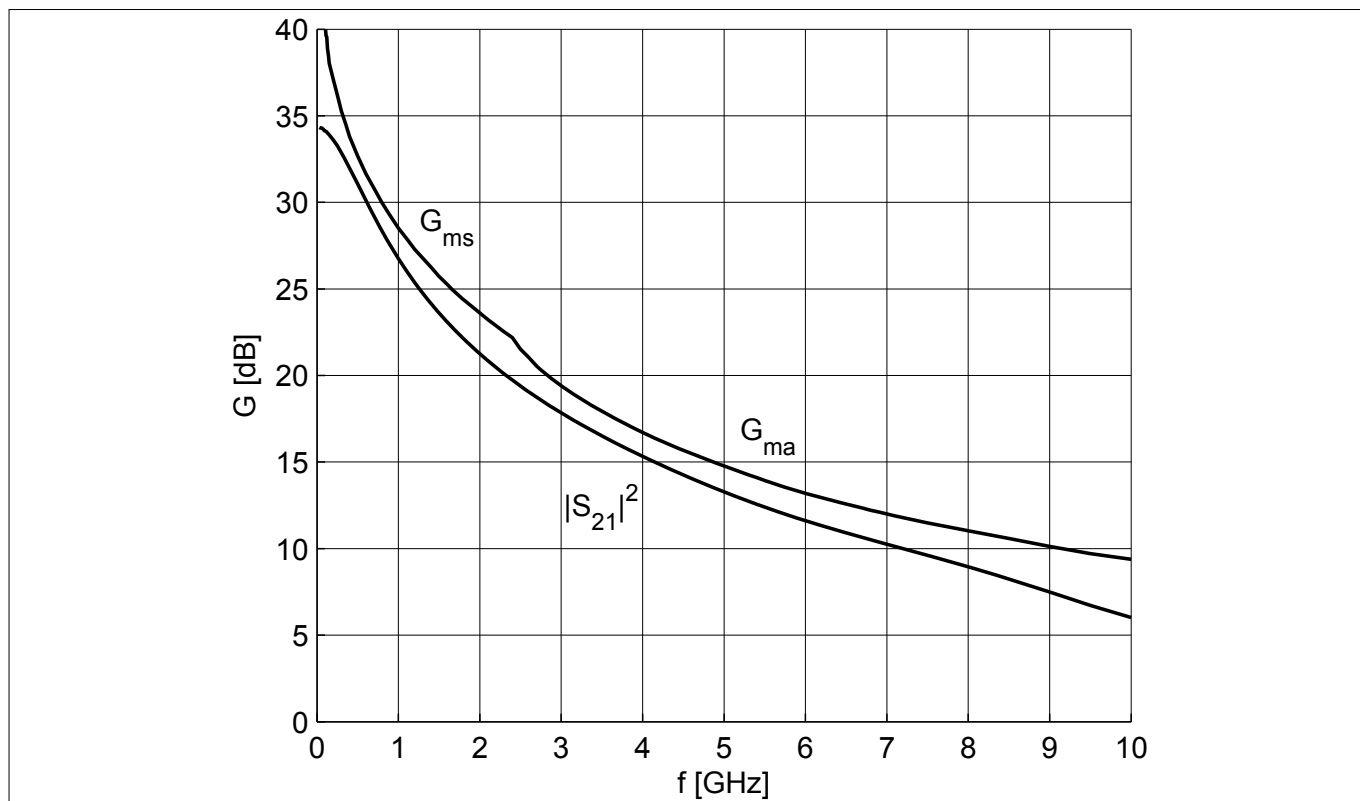


Figure 13 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 3$ V, $I_C = 25$ mA

Electrical characteristics

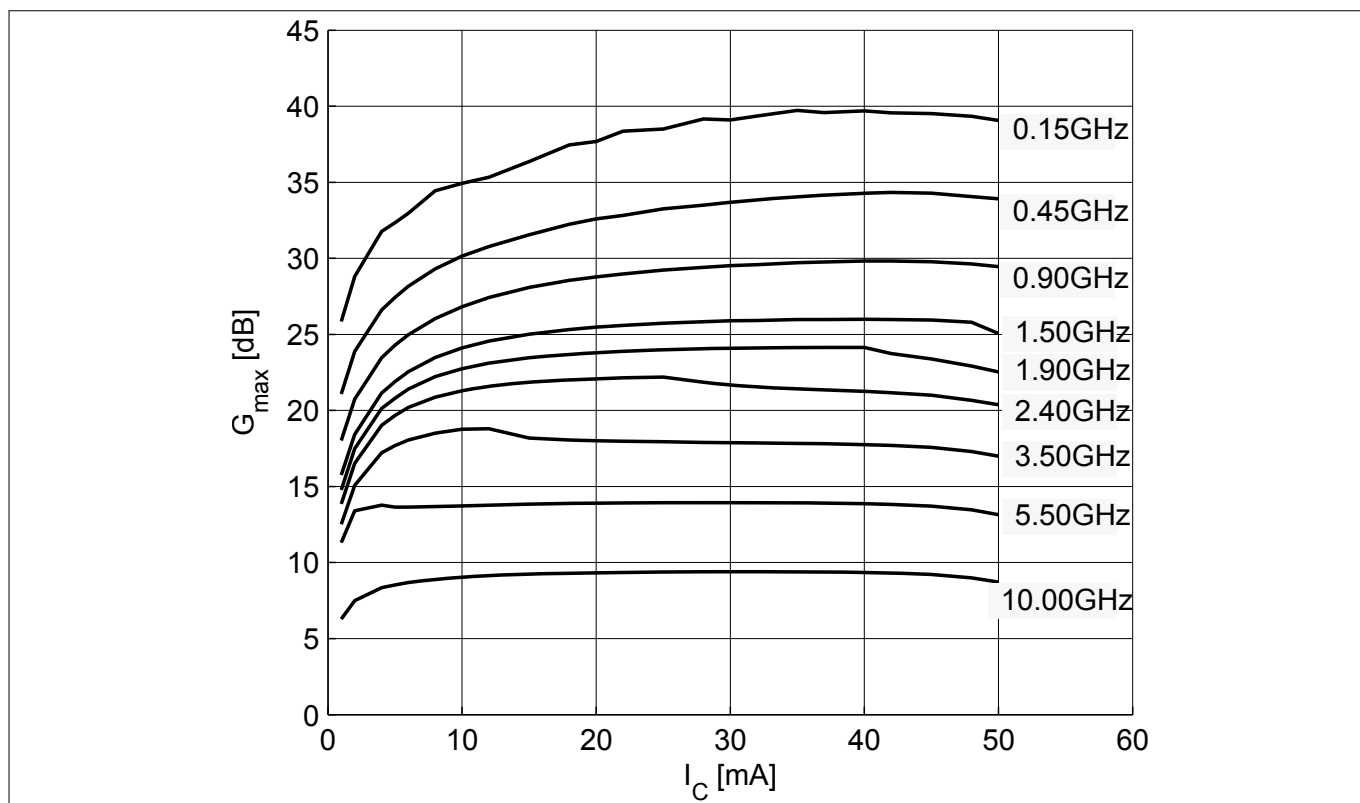


Figure 14 Maximum power gain $G_{\max} = f(I_C)$, $V_{CE} = 3\text{ V}$, $f = \text{parameter in GHz}$

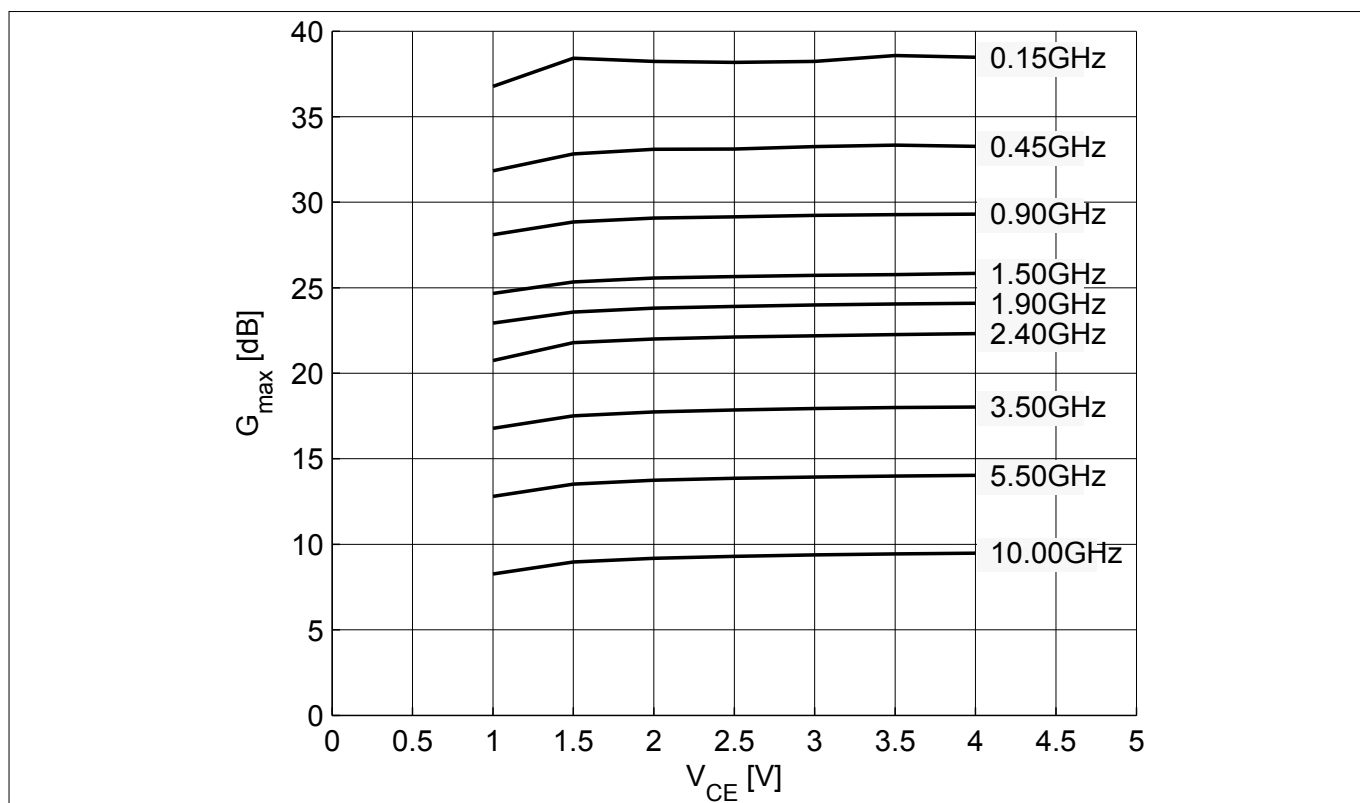


Figure 15 Maximum power gain $G_{\max} = f(V_{CE})$, $I_C = 25\text{ mA}$, $f = \text{parameter in GHz}$

Electrical characteristics

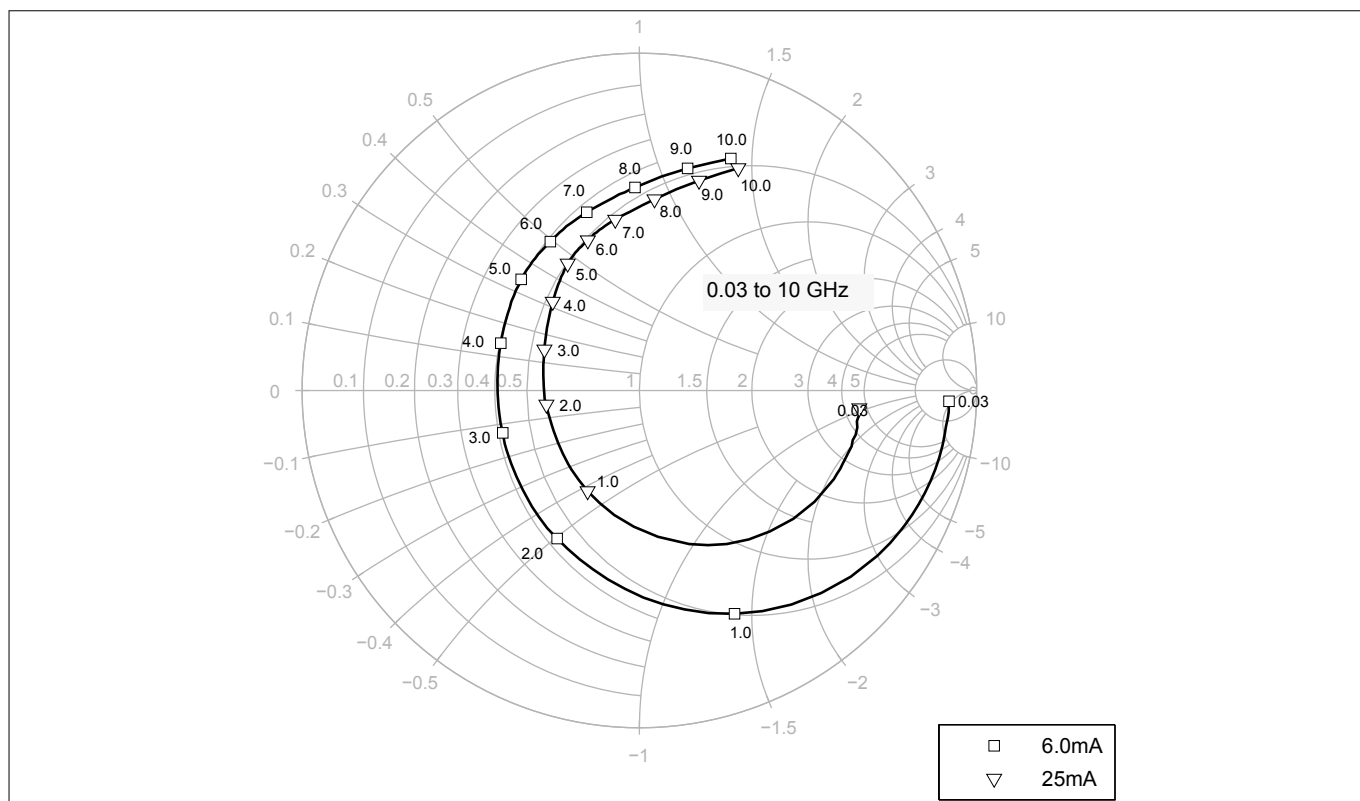


Figure 16 Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 25\text{ mA}$

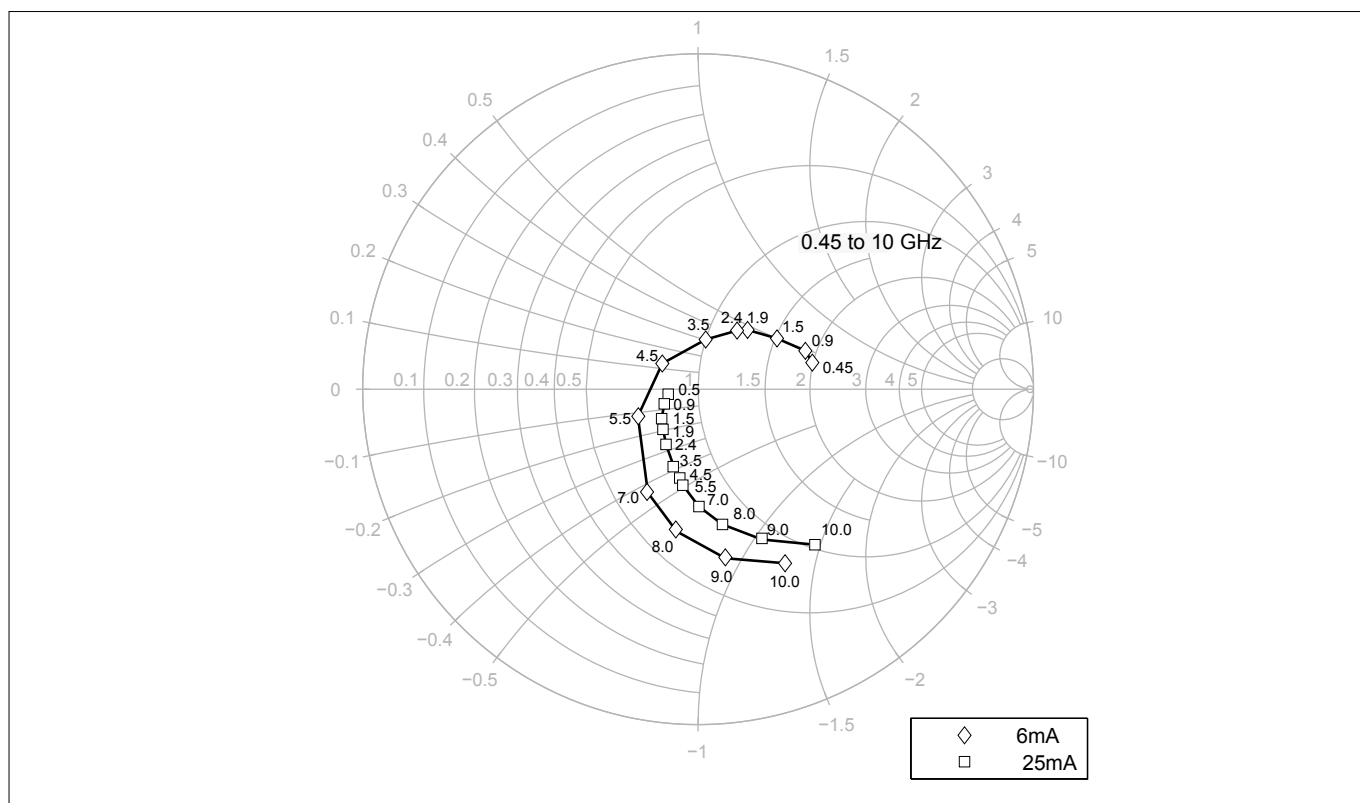


Figure 17 Source impedance for minimum noise figure $Z_{s,opt} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 25\text{ mA}$

Electrical characteristics

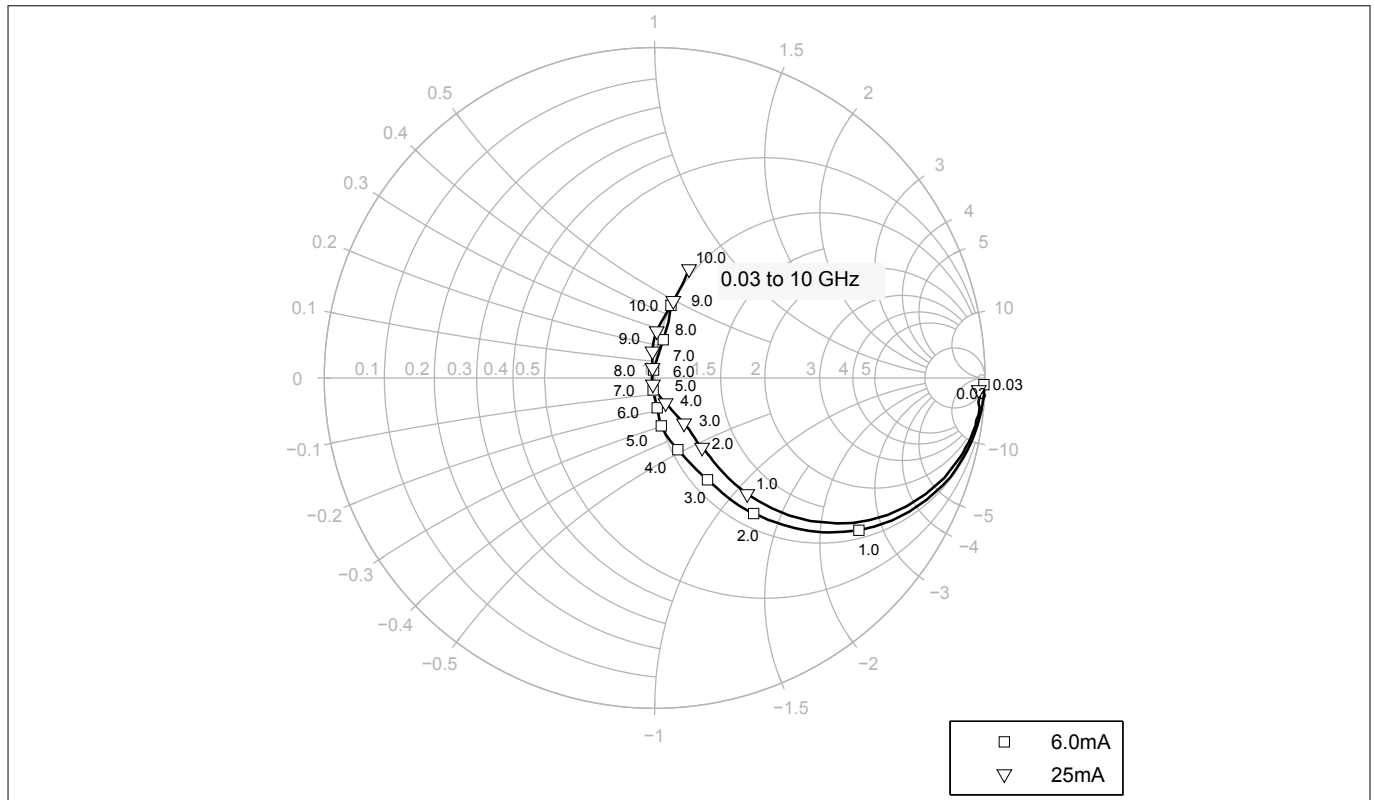


Figure 18 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 25\text{ mA}$

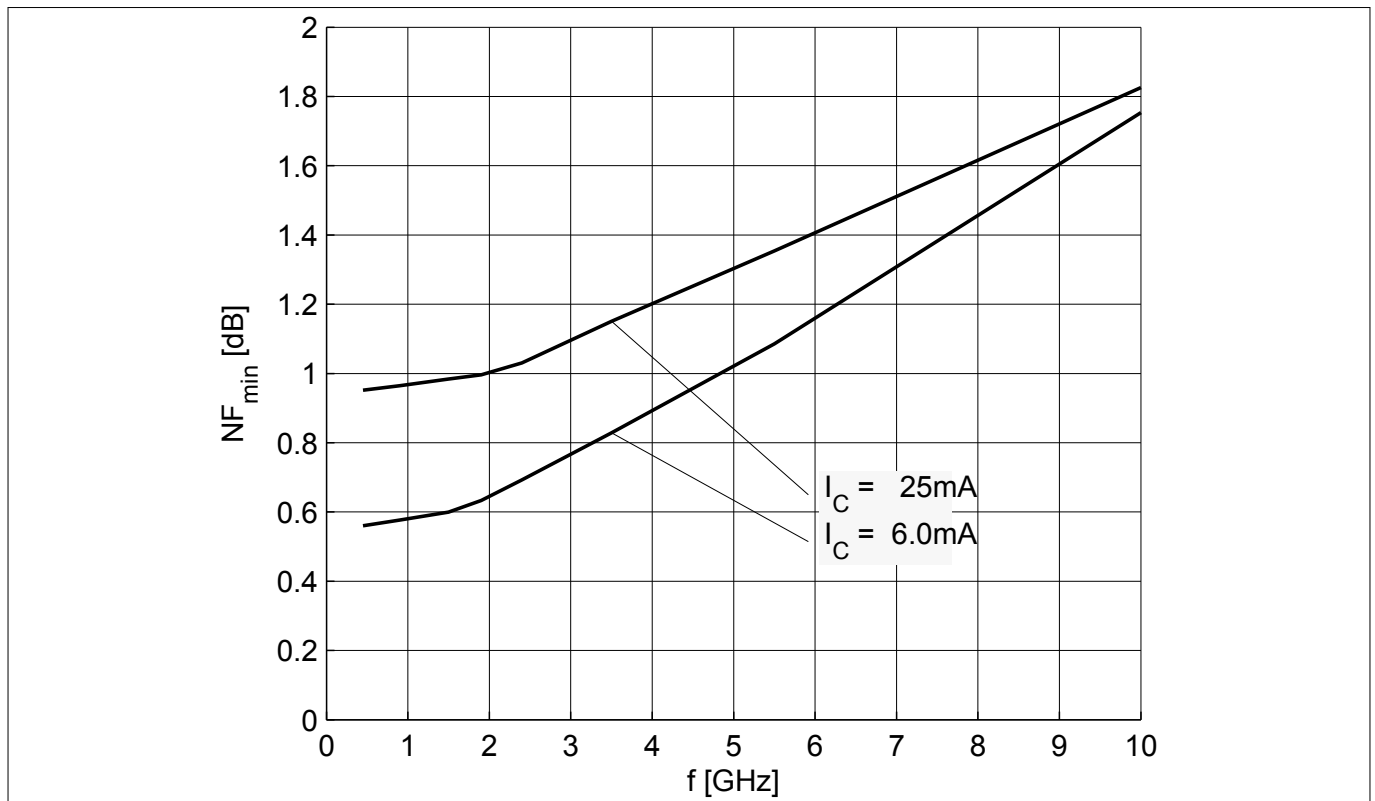


Figure 19 Noise figure $NF_{min} = f(f)$, $Z_S = Z_{S,opt}$, $V_{CE} = 3\text{ V}$, $I_C = 6 / 25\text{ mA}$

Electrical characteristics

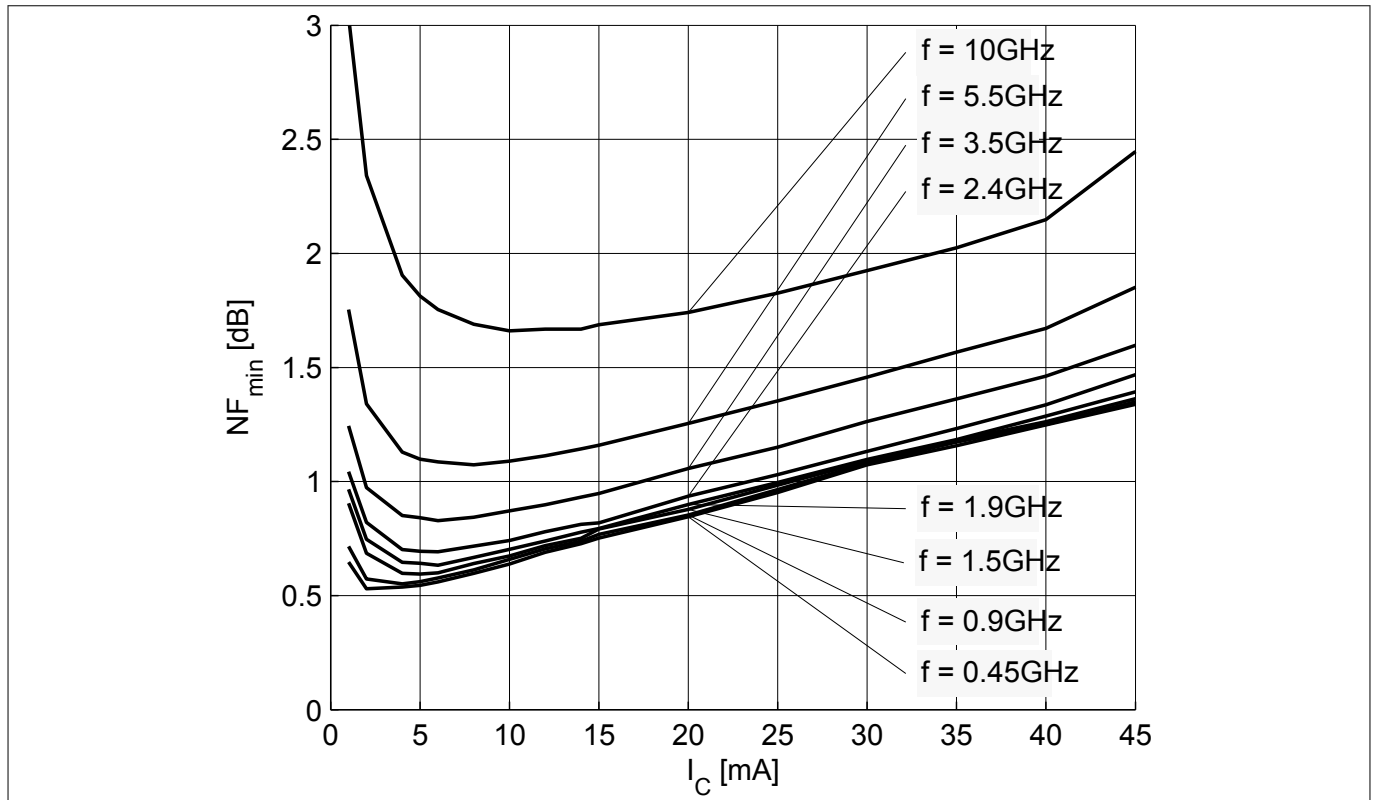


Figure 20

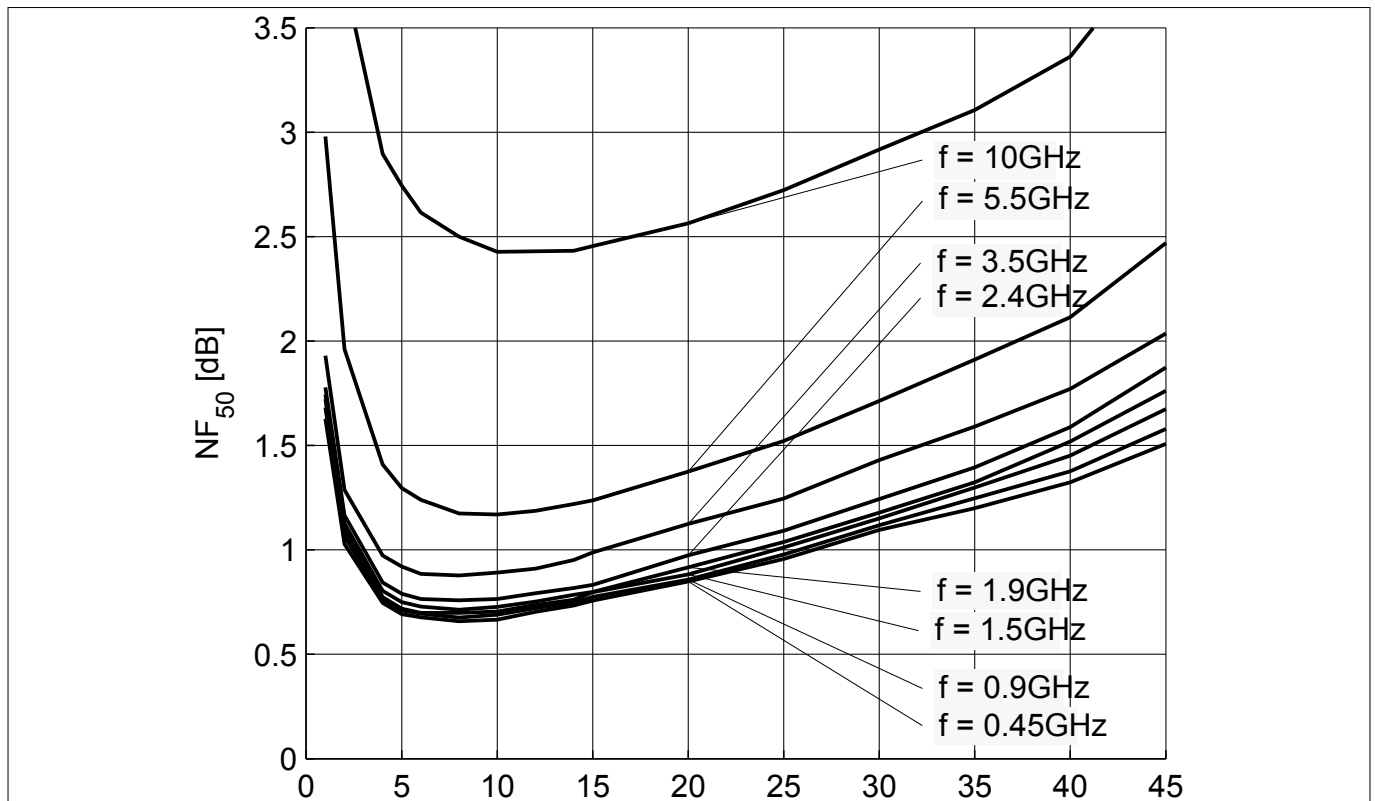
Noise figure $NF_{min} = f(I_C)$, $Z_S = Z_{S,opt}$, $V_{CE} = 3\text{ V}$, $f = \text{parameter in GHz}$ 

Figure 21

Noise figure $NF_{50} = f(I_C)$, $Z_S = 50\ \Omega$, $V_{CE} = 3\text{ V}$, $f = \text{parameter in GHz}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25\text{ }^\circ\text{C}$.

4 Package information SOT343

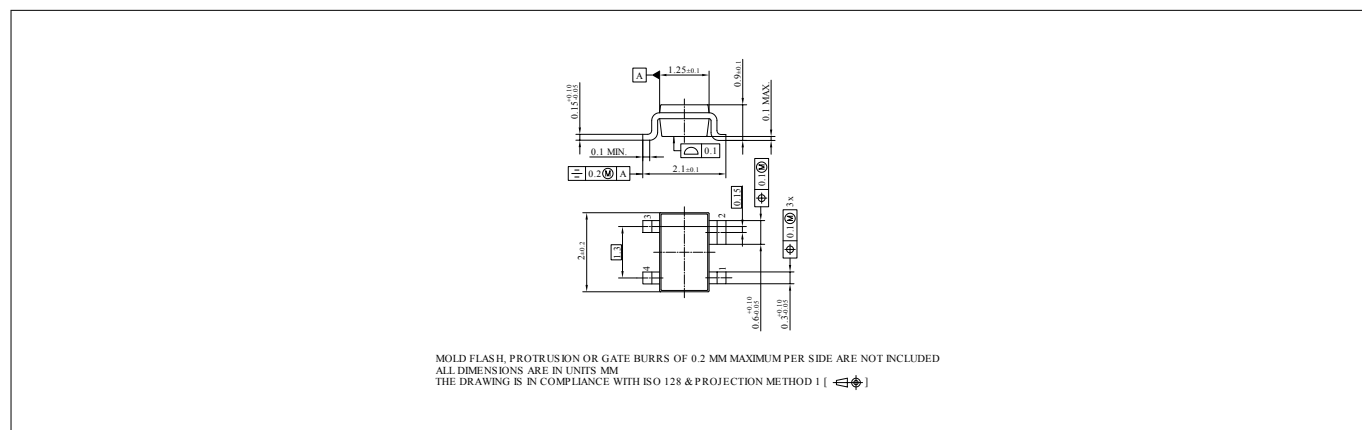


Figure 22 Package outline

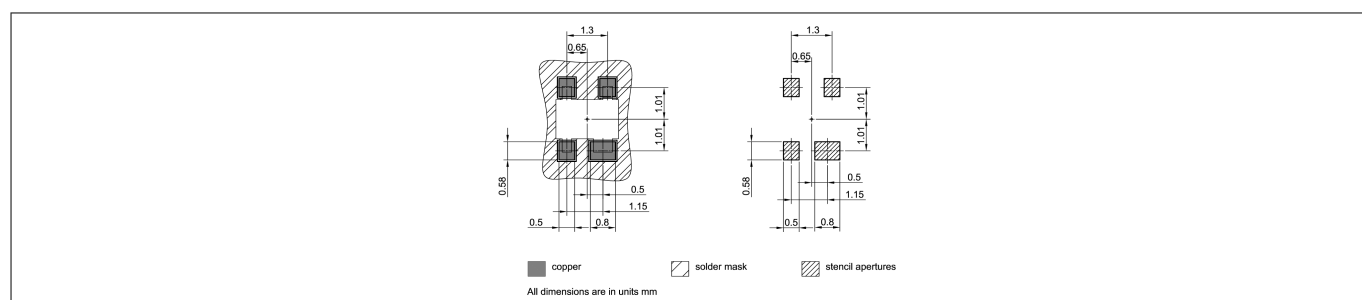


Figure 23 Foot print

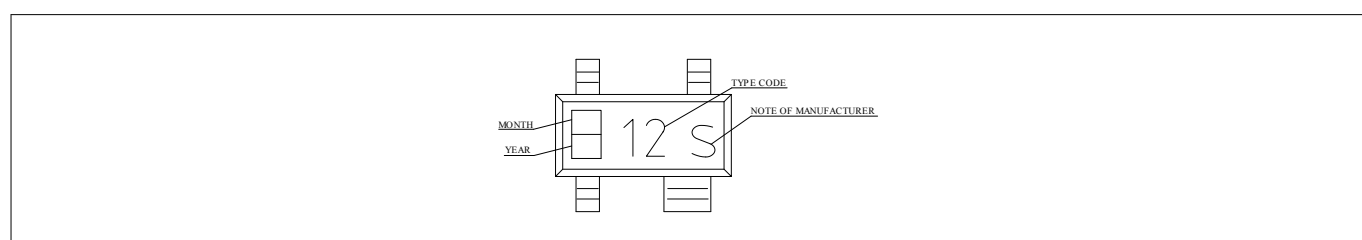


Figure 24 Marking layout example

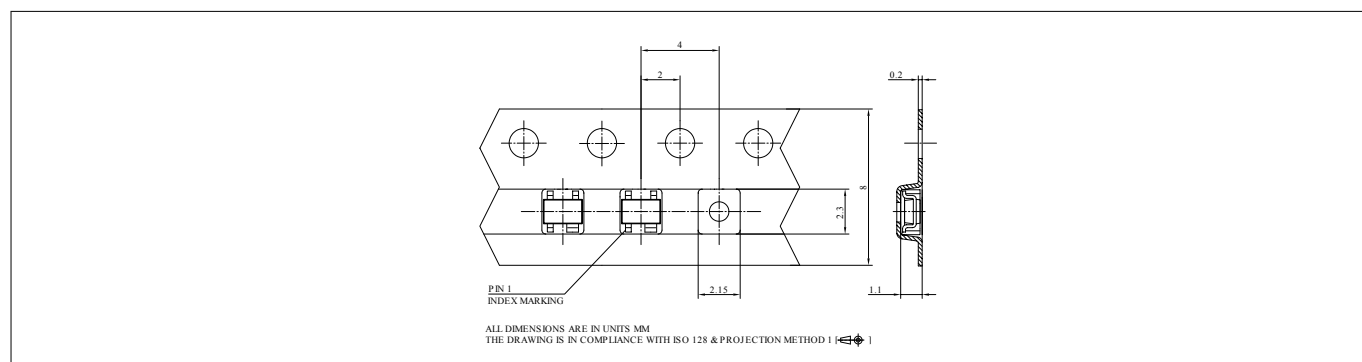


Figure 25 Tape dimensions

Revision history**Revision history**

Document version	Date of release	Description of changes
Revision 3.0	2019-01-25	New datasheet layout.

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Edition 2019-01-25

Published by
Infineon Technologies AG
81726 Munich, Germany

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Document reference
IFX-igo1526291229354

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